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RECORDING COVER SHEET

1. Assignor: Hsiu Wen TU, Wen Chuan CHEN, Mon Nan HO,
Li Huan CHEN, Nai Hua YEH, Yen Cheng HUANG,
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No. 84, Taiho Rd., Chupei
HSINCHU HSIEN, TAIWAN R.O.C.
3. Nature of Conveyance: Assignment of patent
4. Reference number: Application filed herewith.
5. Correspondence to: Keith Kline
PRO-TECHTOR INTERNATIONAL
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6. Number of applications affected by this recording: 1
Total Fee (= # of apps x \$40.00) = \$40.00



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Authorization is hereby given to charge the above to deposit account # 16-2497.

7. Execution date of the document to be recorded: 01/17/01
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9. I declare under penalty of perjury that to the best of my knowledge and belief, the information contained on this cover sheet is true and correct, and that any copy submitted herewith is a true and correct copy of the original document.

10. CERTIFICATE OF MAILING (37 CFR 1.10): I hereby certify that this paper (along with any referred to as being attached or enclosed) is being deposited with the United States Postal Service on the date shown below with sufficient postage as Express Mail in an envelope addressed to: Box New Applications, The Assistant Commissioner for Patents, Washington, D.C. 20231.

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Date: January 24, 2001

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Respectfully submitted,



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20775 Norada Court
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ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR

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(1) Hsiu Wen Tu	No.84 , Taiho Road , Chupei , Hsinchu Hsien , Taiwan	Taiwan
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hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
Kingpak Technology Inc.	No.84 , Taiho Road , Chupei , Hsinchu Hsien , Taiwan	Taiwan

and the successors, assigns and legal representatives of the ASSIGNEE [check one of the following]

☒ the entire right, title, and interest ☐ an undivided _____ percent (____%) interest

in and to any and all improvements which are disclosed in the invention entitled: STACKED PACKAGE STRUCTURE OF IMAGE SENSOR, and which is found in [check one of the following]

- (a) ☒ U.S. patent application executed on 1, 17, 2001.
- (b) ☐ U.S. patent application serial number _____, filed on _____
- (c) ☐ U.S. patent number _____, issued on _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissued or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(1) <i>Hsiu Wen Tu</i>	Hsiu Wen Tu	<i>1/17/2001</i>
(2) <i>Wen Chuan Chen</i>	Wen Chuan Chen	<i>1/17/2001</i>
(3) <i>Mon Nan Ho</i>	Mon Nan Ho	<i>1/17/2001</i>
(4) <i>Li Huan Chen</i>	Li Huan Chen	<i>1/17/2001</i>
(5) <i>Nai Hua Yeh</i>	Nai Hua Yeh	<i>1/17/01</i>

ASSIGNMENT OF INVENTION

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Assignor's Name	Assignor's Residence and/or Address	Nationality
(6) Yen Cheng Huang	No.84 , Taiho Road , Chupei , Hsinchu Hsien , Taiwan	Taiwan
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(8) Jichen Wu	No.84 , Taiho Road , Chupei , Hsinchu Hsien , Taiwan	Taiwan

hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
Kingpak Technology Inc.	No.84 , Taiho Road , Chupei , Hsinchu Hsien , Taiwan	Taiwan

and the successors, assigns and legal representatives of the ASSIGNEE *[check one of the following]*

☒ the entire right, title, and interest ☐ an undivided _____ percent (____%) interest

in and to any and all improvements which are disclosed in the invention entitled: STACKED PACKAGE STRUCTURE OF IMAGE SENSOR, and which is found in *[check one of the following]*

- (a) ☒ U.S. patent application executed on 1, 17, 2001
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and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissued or re-examination thereof.

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ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(6) <i>Yen Cheng Huang</i>	Yen Cheng Huang	<i>1/17/01</i>
(7) <i>Yung Sheng Chiu</i>	Yung Sheng Chiu	<i>1/17/2001</i>
(8) <i>Jichen Wu</i>	Jichen Wu	